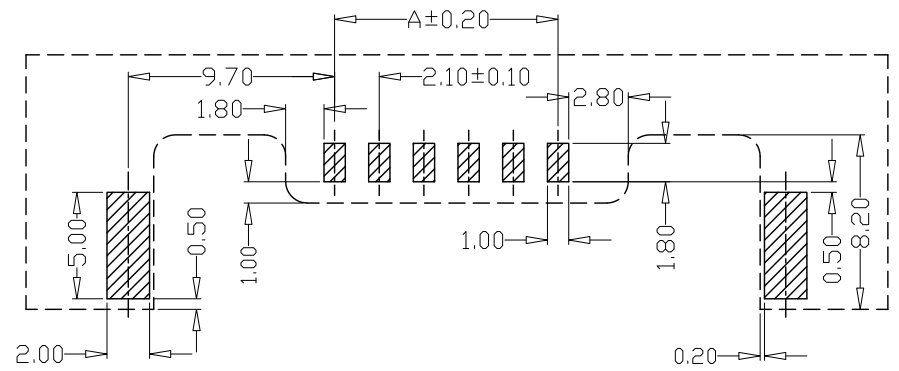
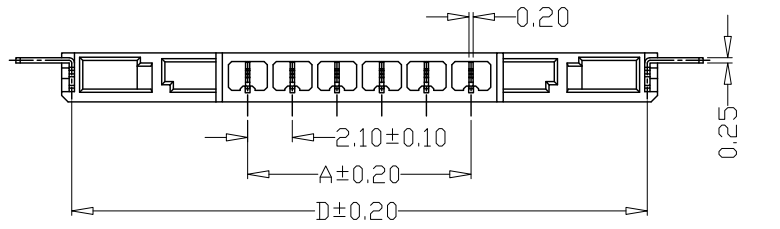
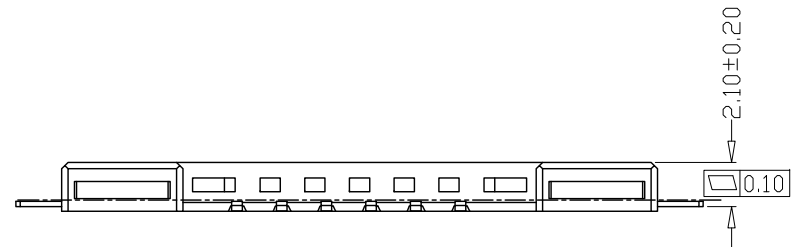
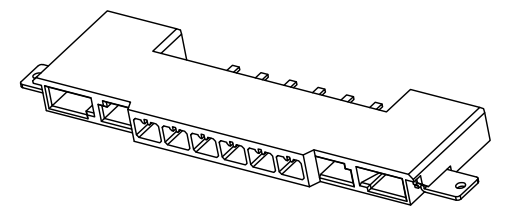
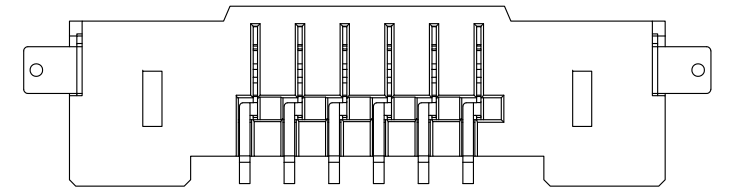
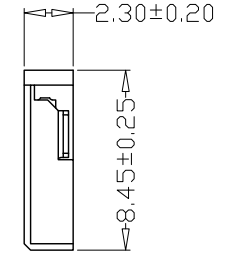
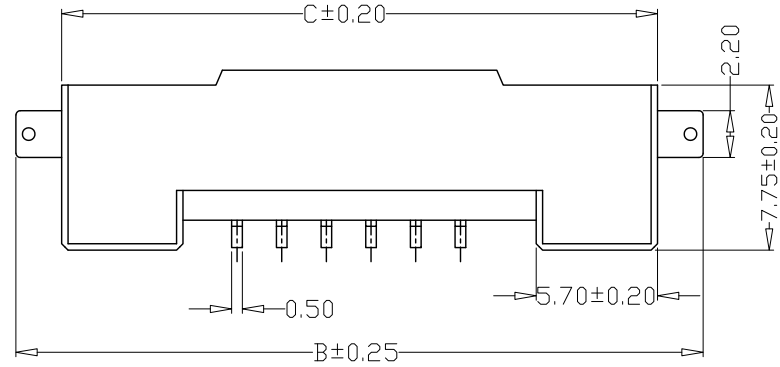


版本 REV.	日期 DATE	变更内容 ECN NO.	变更内容 DESCRIPTION	制图 DRAWN



PCB LAYOUT



SPECIFICATIONS

- 1、Current Rating: 1A AC, DC
- 2、Voltage Rating: 300V AC, DC
- 3、Temperatuer Range: -25°C~+85°C
- 4、Contact Resistance: 30mΩ Max
- 5、Insulation Resistance: 1000MΩ Min
- 6、Withstanding Voltang: 1800V AC/minute
- 7、Material

Wafer: PA6T UL94V-0
 PIN: Phosphor bronze Tin-plated
 Solder tab: Phosphor bronze Tin-plated

PIN	尺寸 (mm)			
	A	B	C	D
-06AWB	10.50	32.50	28.00	27.05
-10AWB	18.90	40.90	36.40	35.45
-10AWB	21.00	43.00	38.50	37.55

GENERAL TOLERANCE		制图 Mapping	张迎春 2022、09、13		料号 PART NO.	B21003-nAWB		版本 REV.	A
X±0.25	X°±2°	审核 Audit	钱岳生 2022、09、13		品名 TITLE	21003 WAFER SMT TYPE		页次 SHEET	1/1
.X±0.25	.X°±1°		核准 Approved		客户料号 CUTM. NO.				
.XX±0.15	.XX°±0.5°	单位 Units	张名 2022、09、14	MM	比例 SCALE		1:1		 乐清市宏一电子有限公司 Yueqing HongYi Electronics Co., Ltd
.XXX±0.10	.XXX°±0.5°								